

MicroNote 108

Determining Clamping Voltage Levels for a Range of Pulse Currents

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Clamping voltage (V_C) is specified only at the maximum limit on most silicon transient voltage suppressor (TVS) datasheets. Often the designer needs to determine the V_C at some intermediate level between breakdown voltage ($V_{(BR)}$) and maximum V_C .

The value can be calculated with the datasheet parameters using the following formula:

$$V_C = (I_P/I_{PP})(V_C \text{ max} - V_{(BR)} \text{ max}) + V_{(BR)} \text{ max}$$

Where:

I_P = actual test pulse current

I_{PP} = maximum rated peak pulse current

V_C = clamping voltage at I_P

$V_C \text{ max}$ = maximum specified clamping voltage

$V_{(BR)} \text{ max}$ = upper limit of breakdown voltage

Based on previous data, a linear increase in V_C can be assumed between $V_{(BR)}$ and $V_C \text{ max}$ for this formula. The V_C versus I_P relationship of the SMCJ15A for a 1.5 kW TVS between $V_{(BR)}$ and V_C as calculated by this method is shown in [Figure 1 \(see page 2\)](#). Results are as expected. This calculation assumes the TVS to be at the upper limit ($V_{(BR)} \text{ max}$), hence it would be conservative for most of the distribution. Note that when I_P equals I_{PP} , V_C equals $V_C \text{ max}$.

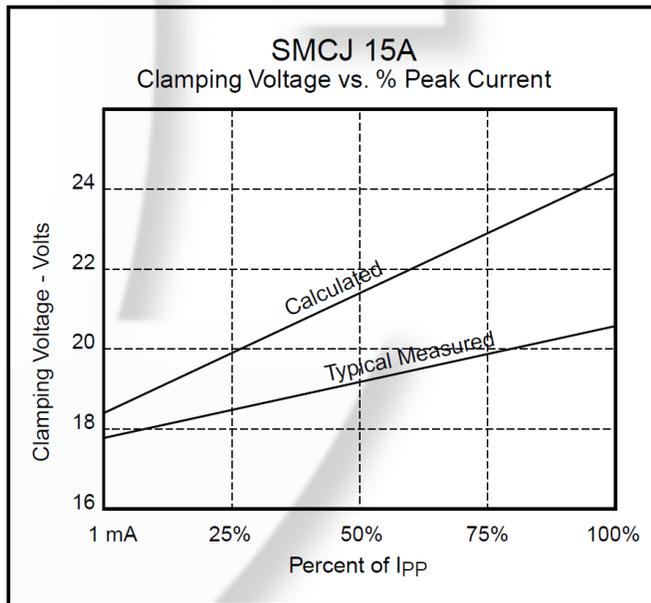
If only $V_{(BR)} \text{ min}$ is listed on the datasheet, $V_{(BR)} \text{ max}$ can be approximated. For “A” suffix parts, multiply $V_{(BR)} \text{ min}$ by 1.2 and for non-suffix parts, multiply by 1.25 to obtain $V_{(BR)} \text{ max}$.

An example of a calculated curve compared to one derived from test measurements ([Figure 1 \(see page 2\)](#)) illustrates the feasibility and conservative aspects of this method. Surge tests were performed on a 20 piece sample at 25 °C with a 10/1000 μs waveform.

The curve based on surge test data has a more-shallow slope than the curve interpolated through calculation. This indicates that the devices are conservatively rated, and that the formula given is adequate for interpolating intermediate values of V_C for a fractional part of I_{PP} .

The linear relationship between I_P and V_C can be applied in determining greater I_{PP} ratings for applications requiring lower than normal values of V_C . In the equation above, insert the desired value for V_C and solve for the higher I_{PP} value. This often requires upgrading to a higher peak pulse power (P_{PP}) rated device.

Figure 1: SMCJ 15A Clamping Voltage vs. % Peak Current



Support

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